

Appl. No. 10/627,785  
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**Amendments to the Specification**

[0018] Referring also to Fig. 3, in use of the heat sink clip 20, the heat sink 10 is placed on the CPU 60 that is mounted on the socket 50. The heat sink clip 20 is placed in the channel of the heat sink 10. The cap 28 is fittingly received in the blind hole 16 of the base 12 of the heat sink 10. The hooks 38, 46 of the first and second locking arms 32, 44 24 are resiliently engaged with undersides of the catches 52 of the socket 50 respectively. The spring 27 is thereby compressed, and urges the longitudinal portion 31 upwardly while simultaneously urging the cap 27 28 downwardly to press the heat sink 10 against the CPU 60. The heat sink 10 is thereby securely attached to the CPU 60.